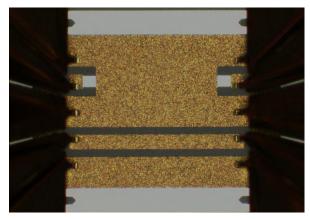
TC5-G5G5G-0100-0125 Calibration Substrate

The MPI TITAN[™] TCS-GSGSG-0100-0125 Dual Calibration Substrate is designed to provide accurate probe tip calibration of MPI TITAN[™] RF probes with ground-signal-ground-signal-ground (GSGSG) tips and the standard's layout is optimized implementing recommendations developed by the PlanarCal Consortium of twelve European organizations^[1]. It supports the industry standard Short-Open-Load-Thru (SOLT/TOSM) calibration method, as well as advanced Thru-Match-Reflect (TMR/LRM), Thru-Match-Reflect-Reflect (TMRR) and the NIST multiline Thru-Reflect-Line (mTRL) calibrations.

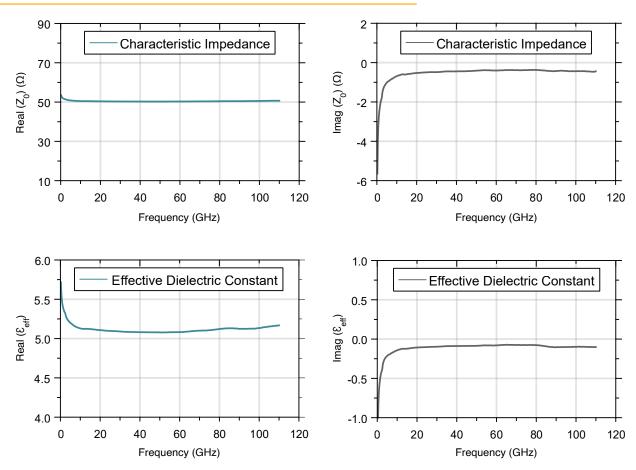


The TCS-GSGSG-0100-0125 contains the full set of coplanar transmission lines for mTRL calibrations up to 220 GHz.

Two opposing GSGSG TITAN™ Dual Probes in separation after touching the Thru (Adj Load) Standard and using 10 µm vertical overtravel.

The unique approach of terminating idle RF probe ports by an Adjacent Load element implemented for MPI's TCS dual calibration substrates family drastically improves calibration accuracy at the mmW frequency range^[2].

TYPICAL ELECTRICAL FIGURES



SUBSTRATE CHARACTERISTICS

Material	Alumina
Size	16.7 mm x 12.7 mm
Thickness	254 μm
Design or standards	Coplanar
Probe configuration	GSGSG
Supported probe pitch	100 to 125 μm
Number of calibration and verification lines	3
Calibration verification elements	yes
Supported calibration methods	TOSM (SOLT), TMR, LRM, SOLR, TMRR, TRL and mTRL
Typical resistance of the load	50 Ω
Typical load trimming accuracy error	± 0.3 %
Open standard	Au pads on substrate
Recommended overtravel for TITAN [™] probes	10 μm

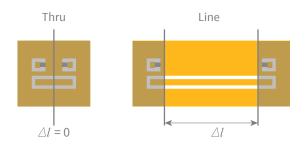
ELECTRICAL CHARACTERISTICS OF CPW LINE STANDARDS

Nominal capacitance per unit length, pF/cm	1.505
Nominal characteristic impedance @20 GHz	50 Ω
Effective dielectric constant @20 GHz, real part	5.02
Velocity factor @20 GHz	0.446
Parameters of the simplified model of line losses	
Reference loss, dB	0.15
Reference delay, ps	10
Reference frequency, GHz	30
Electrical length of line, ps	
Thru (Adj Load)	4.48
Thru (Adj Load) 1 (0201,0208)	6.13
Thru (Adj Load) 2 (0301,0308)	10.61
Thru (Adj Load) 3 (0401,0408)	27.43
Dual Thru (0104, 0105)	4.57
Vertical Thru (0602 - 0607)	2.17

CALIBRATION ACCURACY USING NIST MULTILINE THRU-REFLECT-LINE (mTRL) PROCESS

The mTRL calibration kit can be easily designed and fabricated using the same semiconductor process as the DUT. Customized "On-wafer" mTRL calibration kits eliminate the need for de-embedding the DUT measurement results from parasitic impedances of the device contact pads. The mTRL is the only method that delivers trustable calibration results at measurement frequencies above 220 GHz.

The mTRL algorithm requires multiple Line standards of different physical lengths and always treats the first Line (the "Thru") standard as a zero-length line. As a result, the length of each subsequent Line standard, Delta-I, is defined with respect to the length of the Thru (the first line).



The TRL definition of the Δl for line standards



The MP80-DX MicroPositioner with the digital micrometer on the X axes.

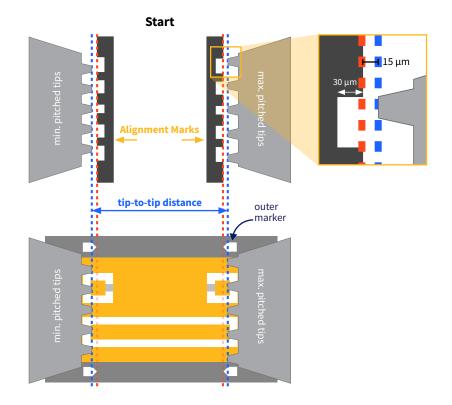
Standard type, (Name)	Physical length, μm	Effective length l, µm	Δl, μm
Thru (Adj Load)	650	600	0
Thru (Adj Load) Line 1 (0201,0208)	870	820	220
Thru (Adj Load) Line 2 (0301,0308)	1470	1420	820
Thru (Adj Load) Line 3 (0401,0408)	3720	3670	3070

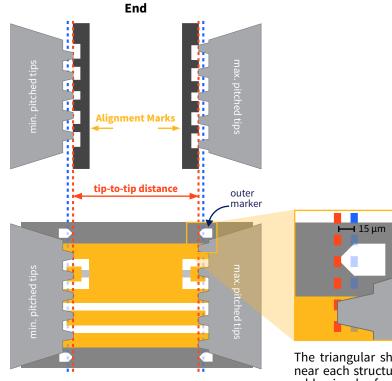
PROBE TIP POSITIONING AND ALIGNMENT MARKS

Consistent and accurate placement of the probe tips on calibration structures is critical for accurate and repeatable system calibration. The MPI TITAN[™] TCS calibration substrate simplifies correct probe-tip-to-structure-alignment by providing special pre-alignment structures for the end user. The pre-alignment structures (Alignment Marks) enable the user to contact the Short, Open, Load and Thru structures in the correct location for consistent calibration results. For the Short, Open and Load, correct alignment is at the middle of each pad (Y-axis or relative to the direction of probe tip skate). For the Thru/Line elements, the correct alignment is 10-15 µm inward from each end of line so the two opposing probes are apart by the specified distance that corresponds to the effective length of the element.

The unique saw-tooth like Alignment Marks (structures # 0802-0807) and cone-shaped Outer Marker found on the TCS calibration substrate are designed for proper probe-tip-to-calibration-structure edge adjustment. The edge of the Alignment Marks (as highlighted by the red dashed line in Figure below) corresponds to the endpoint on a Short, Open, Load or Thru/Line structure when the proper amount of probe overtravel and resulting 10-15 μ m of probe tip skate has been used. Skate begins from the moment the probe tips first make contact to the substrate (See the blue dashed line in Figure below) where initial tip contact should occur.

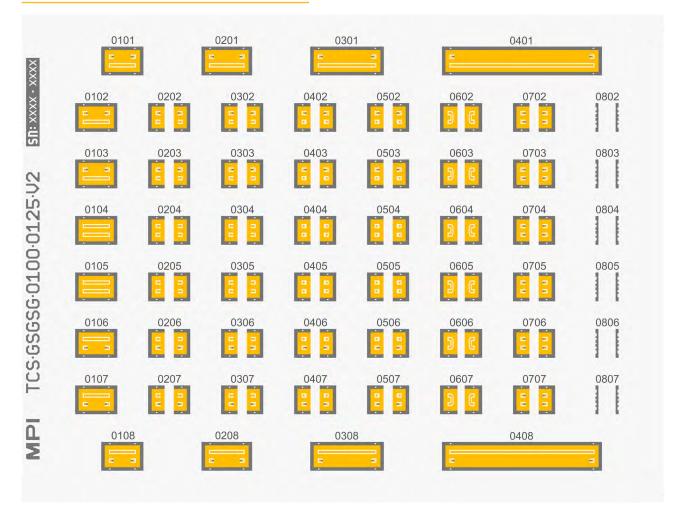
The operator should aim for and use the blue dashed line and cone of the Outer Marker as a visual reference/ starting point for 10-15 μ m of probe tip skate. Minimal vertical overtravel (less than 20 μ m typically) is needed so the tips skate from the blue dashed line (outside saw tooth opening) to the red dashed line (at the edge, but not into the saw tooth opening) as the stopping point. When done properly, two opposing probes are at the correct physical distance and rotational alignment when both are resting at the red dashed line in the example (at the edge of, but not inside, the saw tooth openings on the Alignment Marks).





The triangular shaped marker located near each structure provides a measurable visual reference for the 15 μ m of skate and proper tip placement.

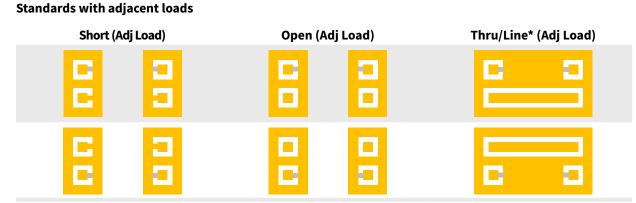
SUBSTRATE LAYOUT



*Location reference elements is 0102.

Dual standards

STANDARD ELEMENTS



*Lines: three choices of transmission lines provided, each with different physical and electrical lengths.

Dual Short	Dual Open	Dual Thru
	88	

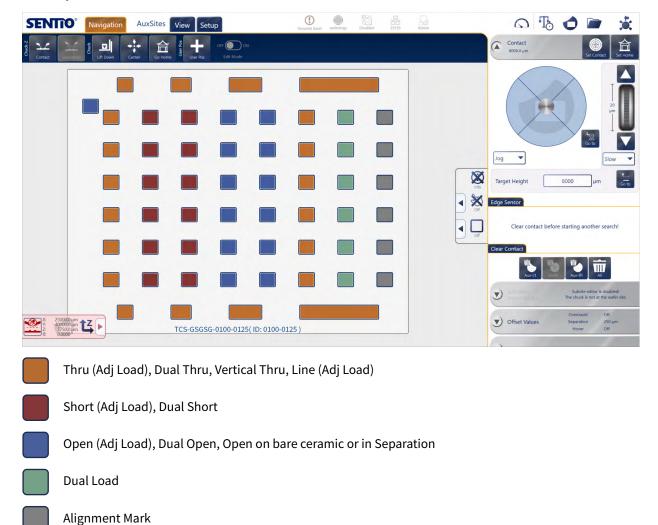


AUTOMATED NAVIGATION IN SENTIO®

SENTIO[®] probe station software from MPI Corporation is powerful Graphical User Interface (GUI) software to take your semiconductor testing to the next level. With unparalleled usability, multi-touch capabilities, and a customizable dashboard, SENTIO[®] software is designed to make your testing and microwave probe calibration processes more efficient and productive. Picture in Picture and QAlibria[®] inside provide advanced data analysis tools, while built-in intelligence streamlines your testing processes and keeps your probes and devices safe.

Connectivity and upgradability mean you're always connected and up to date with the latest features, while scalability ensures that SENTIO[®] software can grow with your business.

SENTIO[®] and QAlibria[®] integrate seamlessly with the structure mapping of your TCS calibration substrate, making standards navigation the calibration process automated and easy even for inexperienced operators.



The map of the TCS-GSGSG-0100-0125 substrate in SENTIO®

STANDARDS

Thru Standards with Adjacent Load

Name	Туре	X μm	Yμm	Spacing µm
0102	Thru (Adj Load)	0	0	600
0103	Thru (Adj Load)	0	-1470	600
0106	Thru (Adj Load)	0	-5880	600
0107	Thru (Adj Load)	0	-7350	600
0101	Thru (Adj Load)	690	1470	600
0108	Thru (Adj Load)	690	-8820	600

Line Standards with Adjacent Load

Name	Туре	X μm	Yμm	Spacing µm
0201	Line1 (Adj Load)	3290	1470	820
0301	Line2 (Adj Load)	6120	1470	1420
0401	Line3 (Adj Load)	9550	1470	3680
0208	Line1 (Adj Load)	3290	-8820	820
0308	Line2 (Adj Load)	6120	-8820	1420
0408	Line3 (Adj Load)	9550	-8820	3680

Short Standards with Adjacent Load

Name	Туре	Xμm	Yμm	Spacing µm
0202	Short (Adj Load)	1900	0	600
0203	Short (Adj Load)	1900	-1470	600
0302	Short (Adj Load)	3800	0	600
0303	Short (Adj Load)	3800	-1470	600
0206	Short (Adj Load)	1900	-5880	600
0207	Short (Adj Load)	1900	-7350	600
0306	Short (Adj Load)	3800	-5880	600
0307	Short (Adj Load)	3800	-7350	600

Open with Adjacent Load

Name	Туре	Xμm	Yμm	Spacing µm
0402	Open (Adj Load)	5700	0	600
0403	Open (Adj Load)	5700	-1470	600
0502	Open (Adj Load)	7600	0	600
0503	Open (Adj Load)	7600	-1470	600
0406	Open (Adj Load)	5700	-5880	600
0407	Open (Adj Load)	5700	-7350	600
0506	Open (Adj Load)	7600	-5880	600
0507	Open (Adj Load)	7600	-7350	600

Name	Туре	Xμm	Yμm	Spacing µm
0104	Dual Thru	0	-2940	600
0105	Dual Thru	0	-4410	600
0204	Dual Short	1900	-2940	600
0205	Dual Short	1900	-4410	600
0304	Dual Short	3800	-2940	600
0305	Dual Short	3800	-4410	600
0404	Dual Open	5700	-2940	600
0405	Dual Open	5700	-4410	600
0504	Dual Open	7600	-2940	600
0505	Dual Open	7600	-4410	600
0702	Dual Load	11400	0	600
0703	Dual Load	11400	-1470	600
0704	Dual Load	11400	-2940	600
0705	Dual Load	11400	-4410	600
0706	Dual Load	11400	-5880	600
0707	Dual Load	11400	-7350	600

Dual Calibration Standards

Vertical (Loop-Back) Thru Standards

Name	Туре	Xμm	Yμm	Spacing µm
0602	Vertical Thru	9500	0	600
0603	Vertical Thru	9500	-1470	600
0604	Vertical Thru	9500	-2940	600
0605	Vertical Thru	9500	-4410	600
0606	Vertical Thru	9500	-5880	600
0607	Vertical Thru	9500	-7350	600

Probe Alignment Elements

Name	Туре	Xμm	Yμm	Spacing µm
0802	Alignment Mark	13300	0	600
0803	Alignment Mark	13300	-1470	600
0804	Alignment Mark	13300	-2940	600
0805	Alignment Mark	13300	-4410	600
0806	Alignment Mark	13300	-5880	600
0807	Alignment Mark	13300	-7350	600

CALIBRATION COEFFICIENTS FOR THE TITAN[™] DUAL PROBES

GSGSG Configuration					
Pitch	Model	C-Open, fF	L-Short, pH	L-Term, pH	
100 µm	26, 40, 50, 67 GHz, Reduced Contact Width (RC)	6.1	40	32	
125 μm	26, 40, 50, 67 GHz, Standard	5.5	39	28.5	

GSGSG Configuration, for the Keysight VNA

		C-Open, fF	L-Short, pH		Load*	
Pitch	Model	C, fF	L, pH	R, Ohm	Offset Z₀, Ohm	Offset delay, ps
100 μm	26, 40, 50, 67 GHz, Reduced Contact Width (RC)	6.1	40	50	500	0.065
125 µm	26, 40, 50, 67 GHz, Standard	5.5	39	50	500	0.058

*Use both offset impedance and offset delay parameters.

REFERENCES

- [1] M. Spirito, U. Arz, G. N. Phung, F. J. Schmückle, W. Heinrich, and R. Lozar, "Guidelines for the design of calibration substrates, including the suppression of parasitic modes for frequencies up to and including 325 GHz," in "EMPIR 14IND02 – PlanarCal," Physikalisch-Technische Bundesanstalt (PTB), 2018.
- [2] H.-C. Fu, K. Jung. "Improve RF Dual Probe Calibration Accuracy with Peer-Terminated Standard", in 2024 IEEE / MTT-S International Microwave Symposium IMS 2024, Washington, DC, USA, 16-24 June, 2024.

See MPI Corporation's Terms and Conditions of Sale for more details.

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